



FCP16N60 / FCPF16N60 600V N-Channel MOSFET

# FCP16N60 / FCPF16N60 600V N-Channel MOSFET

### Features

- 650V @T<sub>J</sub> = 150°C
- Typ. R<sub>ds(on)</sub> = 0.22Ω
- Ultra low gate charge (typ. Qg=55nC)
- Low effective output capacitance (typ. Coss.eff=110pF)
- 100% avalanche testedRoHS Compliant



### Description

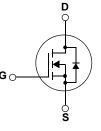
SuperFET<sup>TM</sup> is, Fairchild's proprietary, new generation of high voltage MOSFET family that is utilizing an advanced charge balance mechanism for outstanding low on-resistance and lower gate charge performance.

This advanced technology has been tailored to minimize conduction loss, provide superior switching performance, and withstand extreme dv/dt rate and higher avalanche energy. Consequently, SuperFET is very suitable for various AC/DC power conversion in switching mode operation for system miniaturization and higher efficiency.





TO-220F FCPF Series



## **Absolute Maximum Ratings**

Symbol	Parameter			FCP16N60	FCPF16N60	Unit
V <sub>DSS</sub>	Drain-Source Voltage		600		V	
I <sub>D</sub>	Drain Current	- Continuous ( $T_C = 25^{\circ}C$ ) - Continuous ( $T_C = 100^{\circ}C$ )			16* 10.1*	A A
I <sub>DM</sub>	Drain Current	- Pulsed	(Note 1)	48	48*	А
V <sub>GSS</sub>	Gate-Source voltage			± 30		V
E <sub>AS</sub>	Single Pulsed Avalanche Energy		(Note 2)	450		mJ
I <sub>AR</sub>	Avalanche Current		(Note 1)	16		А
E <sub>AR</sub>	Repetitive Avalanche Energy		(Note 1)	20.8		mJ
dv/dt	Peak Diode Recovery dv/dt		(Note 3)	4.5		V/ns
P <sub>D</sub>	Power Dissipation $(T_C = 25^{\circ}C)$ - Derate above 25°C			167 1.33	37.9 0.3	W W/°C
T <sub>J,</sub> T <sub>STG</sub>	Operating and Storage Temperature Range			-55 to +150		°C
Τ <sub>L</sub>	Maximum Lead Temperature for Soldering Purpose, 1/8" from Case for 5 Seconds			300		°C

\*Drain current limited by maximum junction temperature

### **Thermal Characteristics**

Symbol	Parameter	FCP16N60	FCPF16N60	Unit
$R_{ ext{ heta}JC}$	Thermal Resistance, Junction-to-Case	0.75	3.3	°C/W
$R_{ ext{ heta}JA}$	Thermal Resistance, Junction-to-Ambient	62.5	62.5	°C/W

Package	e Mark	ing and Order	ring In	formati	on					
Device Marking		Device	Package		Reel Size Tap		e Width		Quantity	
FCP16N60 FCP16N60		FCP16N60	TO-220		-		-		50	
FCPF1			-220F	-		-		50		
Electric	al Cha	racteristics T <sub>c</sub>	; = 25°C unle	ss otherwise no	ted					
Symbol		Parameter			Conditions		Min	Тур	Max	Units
Off Charac	teristics									
BV <sub>DSS</sub>	V <sub>DSS</sub> Drain-Source Breakdown Voltage		$V_{GS} = 0V, I_D = 250\mu A, T_J = 25^{\circ}C$		600			V		
				$V_{GS} = 0V, I_D = 250\mu A, T_J = 150^{\circ}C$				650		V
$\Delta BV_{DSS}$ / $\Delta T_J$	Breakdov Coefficier	vn Voltage Temperatu nt	re	$I_D = 250\mu A$ , Referenced to $25^{\circ}C$			0.6		V/°C	
BV <sub>DSS</sub>	BV <sub>DSS</sub> Drain-Source Avalanche Breakdown Voltage		V <sub>GS</sub> = 0V, I <sub>D</sub> = 16A			700		V		
I <sub>DSS</sub>	Zero Gate	e Voltage Drain Curre	nt	$V_{DS} = 600V, V_{GS} = 0V$ $V_{DS} = 480V, T_{C} = 125^{\circ}C$				1 10	μΑ μΑ	
I <sub>GSSF</sub>	Gate-Boo	ly Leakage Current, F	orward	$V_{GS} = 30V, V_{DS} = 0V$				100	nA	
I <sub>GSSR</sub>	Gate-Boo	Gate-Body Leakage Current, Reverse		$V_{GS} = -30V, V_{DS} = 0V$				-100	nA	
On Charac	teristics									
V <sub>GS(th)</sub>	Gate Threshold Voltage		$V_{DS} = V_{GS}, I_D = 250 \mu A$		3.0		5.0	V		
R <sub>DS(on)</sub>	Static Drain-Source On-Resistance		V <sub>GS</sub> = 10V, I <sub>D</sub> = 8A			0.22	0.26	Ω		
9 <sub>FS</sub>	Forward <sup>-</sup>	Transconductance		$V_{DS} = 40V$	′, I <sub>D</sub> = 8A	(Note 4)		11.5		S
Dynamic C	haracteris	stics							•	•
C <sub>iss</sub>	Input Capacitance Output Capacitance Reverse Transfer Capacitance		V <sub>DS</sub> = 25V, V <sub>GS</sub> = 0V, f = 1.0MHz			1730	2250	pF		
C <sub>oss</sub>						960	1150	pF		
C <sub>rss</sub>						85		pF		
C <sub>oss</sub>	Output Capacitance		$V_{DS} = 480V, V_{GS} = 0V, f = 1.0MHz$			45	60	pF		
C <sub>oss</sub> eff.	Effective Output Capacitance		$V_{DS}$ = 0V to 400V, $V_{GS}$ = 0V			110		pF		
Switching	Character	istics								
t <sub>d(on)</sub>	Turn-On Delay Time		$V_{DD} = 300V, I_D = 16A$			42	85	ns		
t <sub>r</sub>	Turn-On	Rise Time		$R_G = 25\Omega$	$\zeta_{\rm G} = 25\Omega$			130	270	ns
t <sub>d(off)</sub>	Turn-Off I	Delay Time					165	340	ns	
t <sub>f</sub>	Turn-Off	Fall Time			(N	ote 4, 5)		90	190	ns
Qg	Total Gate	e Charge		V <sub>DS</sub> = 480V, I <sub>D</sub> = 16A V <sub>GS</sub> = 10V				55	70	nC
Q <sub>gs</sub>	Gate-Sou	urce Charge					10.5	13	nC	
Q <sub>gd</sub>	Gate-Dra	in Charge			(N	ote 4, 5)		28		nC
Drain-Sour	ce Diode	Characteristics and	Maximum	Ratings					-	•
I <sub>S</sub>	Maximum Continuous Drain-Source Dio		de Forward Current				16	Α		
I <sub>SM</sub>	Maximum Pulsed Drain-Source Diode Fo		e Diode Fo	prward Current					48	Α
V <sub>SD</sub>	Drain-So	urce Diode Forward V	'oltage	V <sub>GS</sub> = 0V, I <sub>S</sub> =16A				1.4	V	
t <sub>rr</sub>	Reverse	Recovery Time		$V_{GS} = 0V,$				435		ns
Q <sub>rr</sub>	Reverse	Recovery Charge		$dI_F/dt = 100$	DA/μs	(Note 4)		7.0		μC

NOTES:

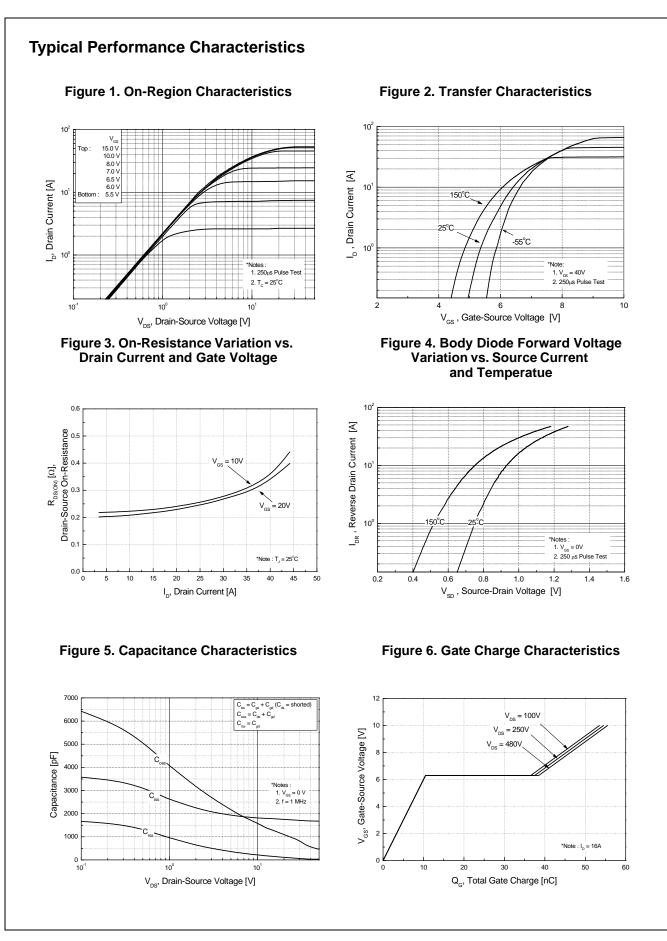
1. Repetitive Rating: Pulse width limited by maximum junction temperature

2.  $I_{AS}$  = 8A,  $V_{DD}$  = 50V,  $R_{G}$  = 25 $\Omega$ , Starting  $T_{J}$  = 25 $^{\circ}C$ 

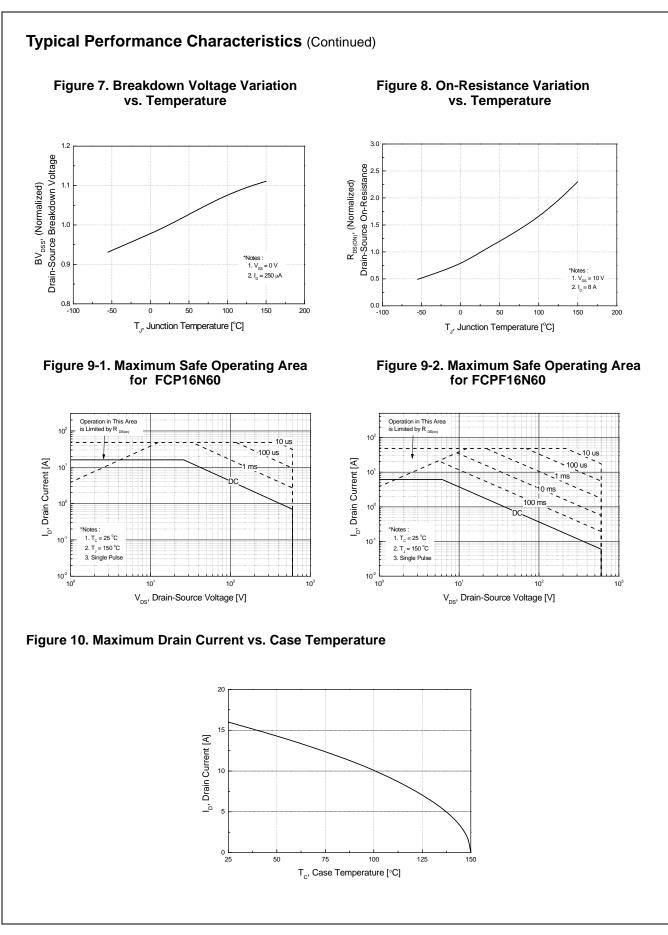
3.  $I_{SD} \leq$  16A, di/dt  $\leq$  200A/µs,  $V_{DD} \leq BV_{DSS},$  Starting  $T_J$  = 25°C

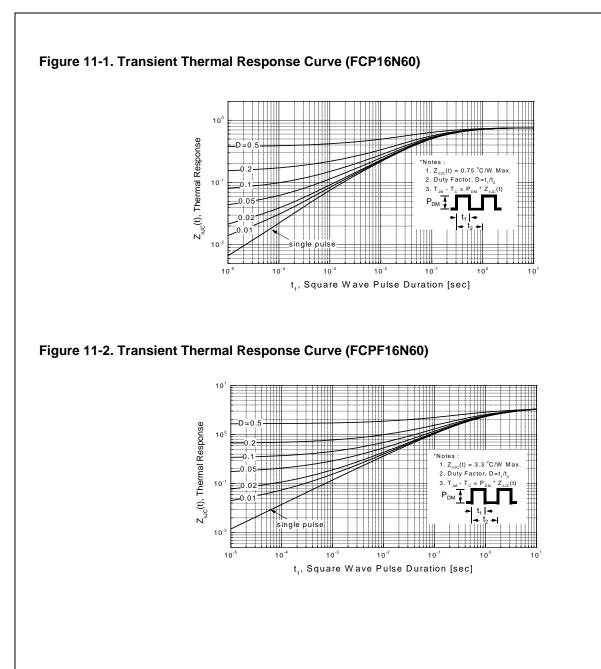
4. Pulse Test: Pulse width  $\leq 300 \mu \text{s}, \, \text{Duty Cycle} \leq 2\%$ 

5. Essentially Independent of Operating Temperature Typical Characteristics

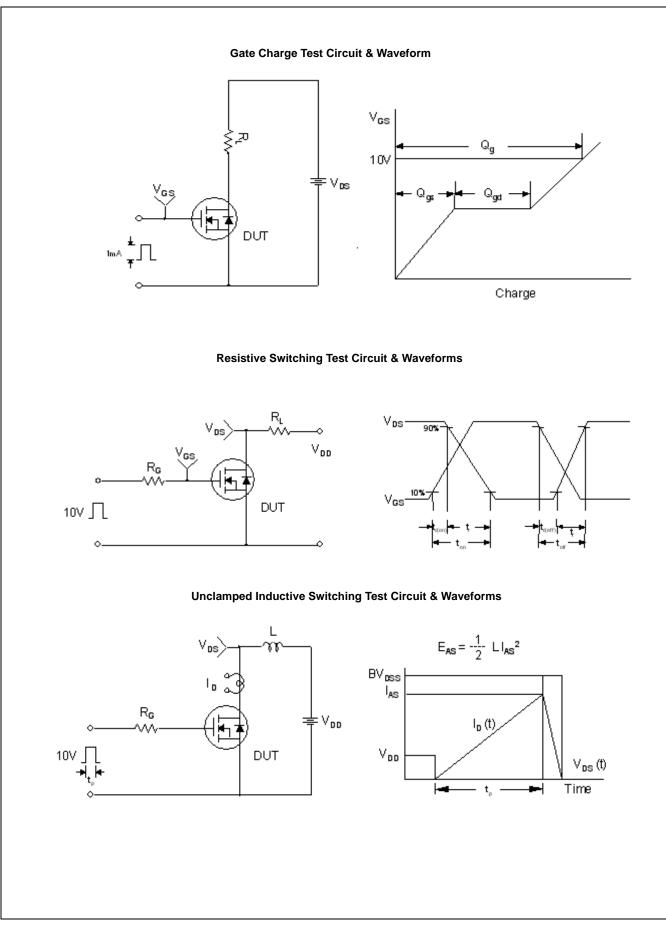


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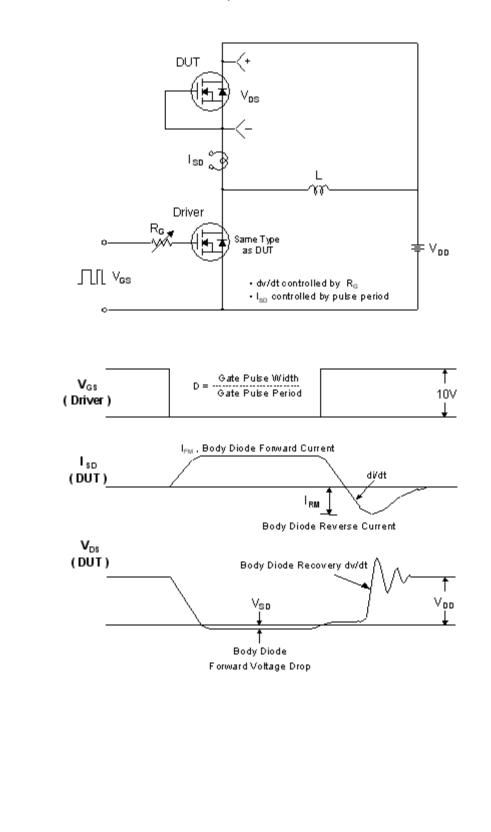


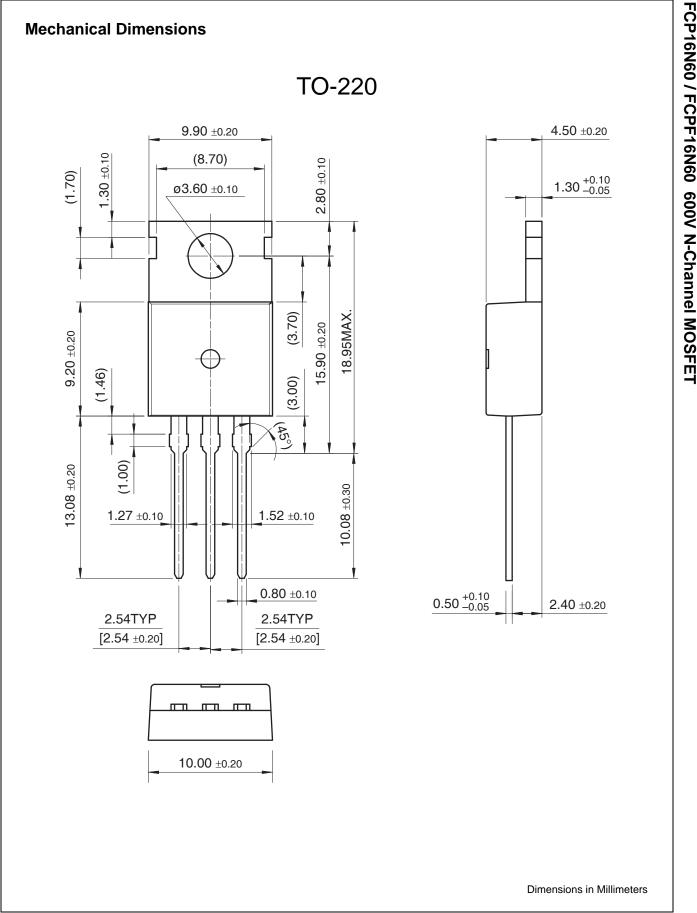
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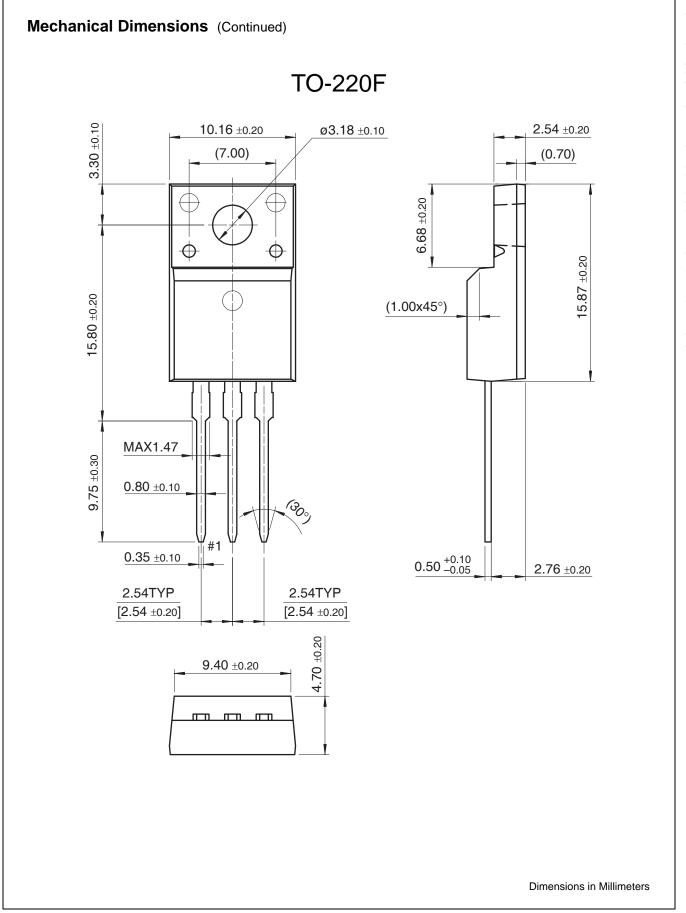


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### Peak Diode Recovery dv/dt Test Circuit & Waveforms









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